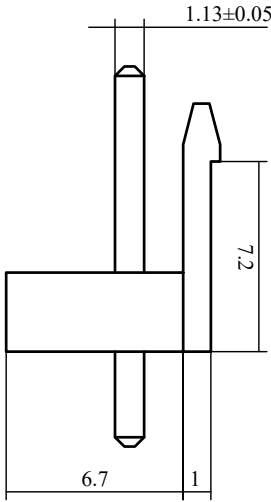


REV.	EC#	DESCRIPTION	DATE	DRAWN	CHECK	APPROVED
1.00		初版发行	2018-05-28	瞿寿坤	胡海萍	胡海萍

NUMBER OF PINS	DIM.A	DIM.B
10P	35.64	39.60
9P	31.68	35.64
8P	27.72	31.68
7P	23.76	27.72
6P	19.8	23.76
5P	15.84	19.8
4P	11.88	15.84
3P	7.92	11.88
2P	3.96	7.92



适应基板厚度: 1.2mm~1.6mm
 温度范围: -25℃~85℃
 额定电压: 250V AC/DC
 额定电流: 7A
 接触电阻: ≤0.01Ω
 绝缘电阻: ≥1000MΩ
 耐压: 1500V AC/minute

技术要求:

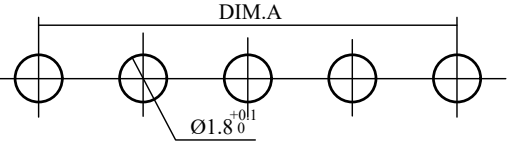
- 1) 材质: 见附表;
- 2) 电镀: 见附表;
- 3) 塑件表面平整、光洁、无毛刺、气泡、烧焦、变形、浇口无拉伤、多料或缺料等不良现象;
- 4) 端子表面无氧化、电镀不良等现象。

2	PIN	n PCS	材质: 黄铜, 电镀: 镀亮锡60u"MIN
1	Housing	1 PCS	材质: PA66, 颜色: 本色
NO.	NAME	Q'TY	DESCRIPTION

深圳市虹成电子有限公司

DRAW:	瞿寿坤	2018-04-22	TITLE:	WAFER 3.96VHA 立式 DIP	DRAW NAME:	HCZZ0324-5
DESIGN:	瞿寿坤	2018-04-22	SERIES:	1501 SERIES	DRAW NO.:	
CHECK:	胡海萍	2018-04-22	P/N:		UNIT:	mm
APPROVED:	胡海萍	2018-04-22	SCALE:	N/A	SHEET:	1/1
CUSTOMER DRAWING			REV. 1.00	SCALE N/A	+	

GENERAL TOLERANCES			
DIM	TOL	DIM	DEG
X.		X°.	±3.00°
X.X	±0.35	X.X°	±2.00°
X.XX	±0.25	X.XX°	±1.00°
X.XXX	±0.15	X.XXX°	



PCB LAYOUT